

### Features

- CMOS High Voltage Process: 9V-30V Display Panel Supply Compatible
- 128 Output Channels, Cascadable; Configurable 120-Output Mode
- 150mA Maximum Current Capability per channel (two channels maximum active simultaneously)
- 20 Ohm Maximum Row Switch "On" Resistance
- Token-Based Control: Bidirectional data transfer; Single and Dual-Token Mode
- Current Source Magnitude User Control: 4  $\mu$ A to 1 mA
- 6-Bit Monochromatic/Color Gray-Scale User Control
- Monochromatic Voltage Precharge Options
- 3.3 V to 5 V logic supply
- Up to 100kHz clock frequency
- Gold-Bumped Die @ ~ 60 micron Output Pitch
- TCP packaging
- Companion to MXED102  
240-Channel OLED Column Driver

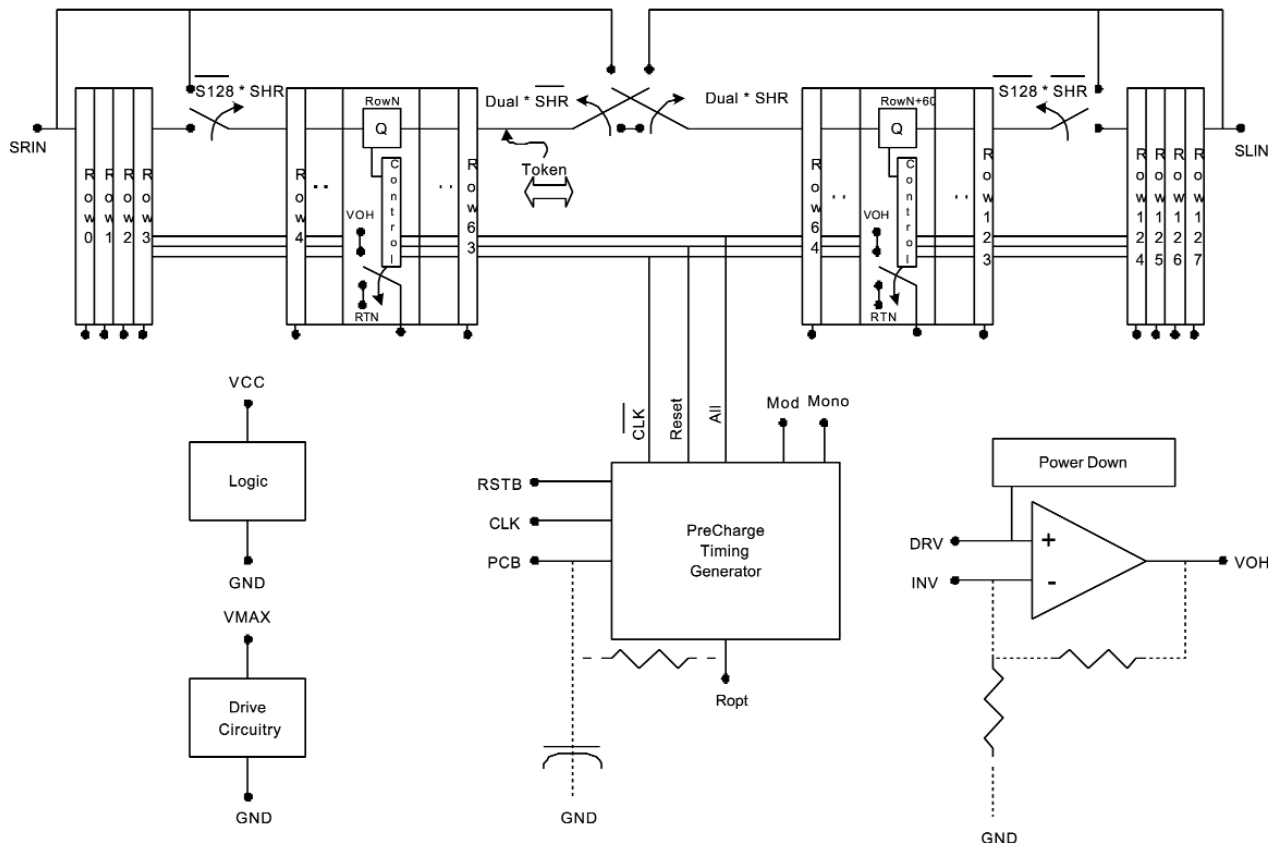
### Description

The MXED202 Row Driver supports up to 128-row OLED panel displays. The MXED202 has low "on" switch resistance, and support of voltage precharge options, ensures uniform luminance at rapid row scan rates. This is the first ASSP production row driver for OLED display OEM's, enabling the development and manufacture of this new standard in flat-panel display technology.

### For All Passive-Matrix Organic-Light-Emitting-Diode Displays

- Monochrome and Color
- Small-Molecule and Polymer
- Common-Cathode Row Switching

### Functional Block Diagram



Preliminary

## PRELIMINARY ELECTRICAL DATA SHEET

The MXED202 is a row-multiplexed display driver, for Passive Matrix Organic Light Emitting Diode (OLED) and Polymer Light Emitting Diode arrays (PLED, PolyLED, LEP, . . .), with anodes connected to current-sourcing column data drivers. The common cathode rows (channels) of the display matrix are activated by sequentially switching them to a low impedance voltage source (ground/0V, typically) in synchronism with the digital data column current drive. The MXED202 supports precharging options to improve luminance control. It is manufactured in a high voltage (30 V) CMOS process and provided in bumped die and TCP (Tape Carrier Package) form.

### Overview

A row-scan token bit is passed along the length of MXED202 shift register to successively activate the row switches. The OLED cathodes of the active row(s) are switched to RTN, a low impedance return, ground or 0V typically, while the companion column drivers source data-driven currents through each OLED to be illuminated. Inactive rows are connected to a programmable "Off" (or Precharge) voltage to ensure the OLED's are not forward-biased. A programmable precharge interval and programmable precharge voltage are available to set initial conditions for the next active row(s).

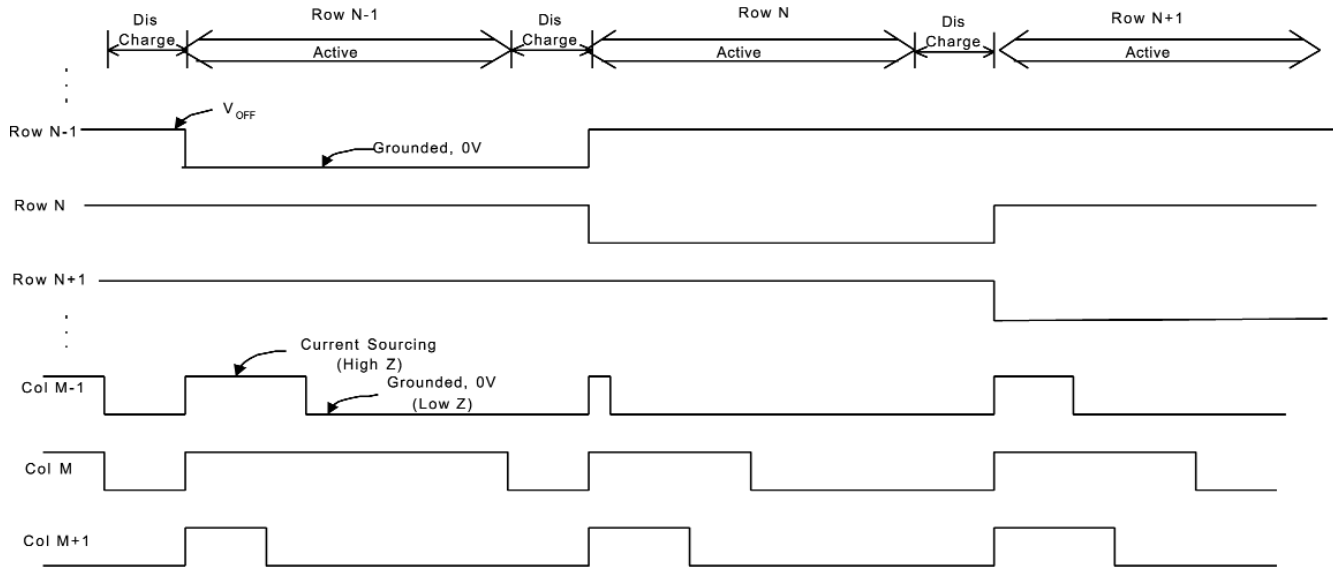
In normal, or single token mode, the token may be entered at either end of the MXED202 row shift register (SRIN or SLIN), depending on the shift direction selection Shift Right (SHR). The token is shifted one row (one channel) per clock cycle, CLK. One row maximum is active at a time. In dual mode (DUAL), the token is entered at one end and automatically in the center, and again the tokens may be selectively shifted left or right at the CLK rate; two rows maximum are active at a time. The MXED202 has options for 128- and 120-row display panels. When the Select 128 (S128) pin is tied low, the token is also automatically entered at the fifth cell from the entry direction end; only the 120 middle outputs, Rows 4 through 123, should be used. Note that a lesser number of rows may be used by resetting the MXED202 (RSTB) at any time, truncating the shift cycle.

### Overview of Operation

A row-scan token bit is passed along the length of MXED202 shift register to successively activate the row switches. The OLED cathodes of the active row(s) are switched to RTN, a low impedance return, ground or 0V typically, while the companion column drivers source data-driven currents through each OLED to be illuminated. Three successive row activations, N-1, N, N+1, are depicted in the simplified timing diagram below. Inactive rows are connected to a programmable "Off" (or Precharge) voltage to ensure the OLED's are not forward-biased. A programmable precharge interval and programmable precharge voltage are available to set initial conditions for the next active row(s). Precharge is described on page 9.

**Simplified Timing Diagram**

OLED Row-Column Driver Timing Waveforms (no Precharge)



**Token:**

The row-scan token(s) activate row switches. Token entry positions, 0 to 127, are defined in the table below:

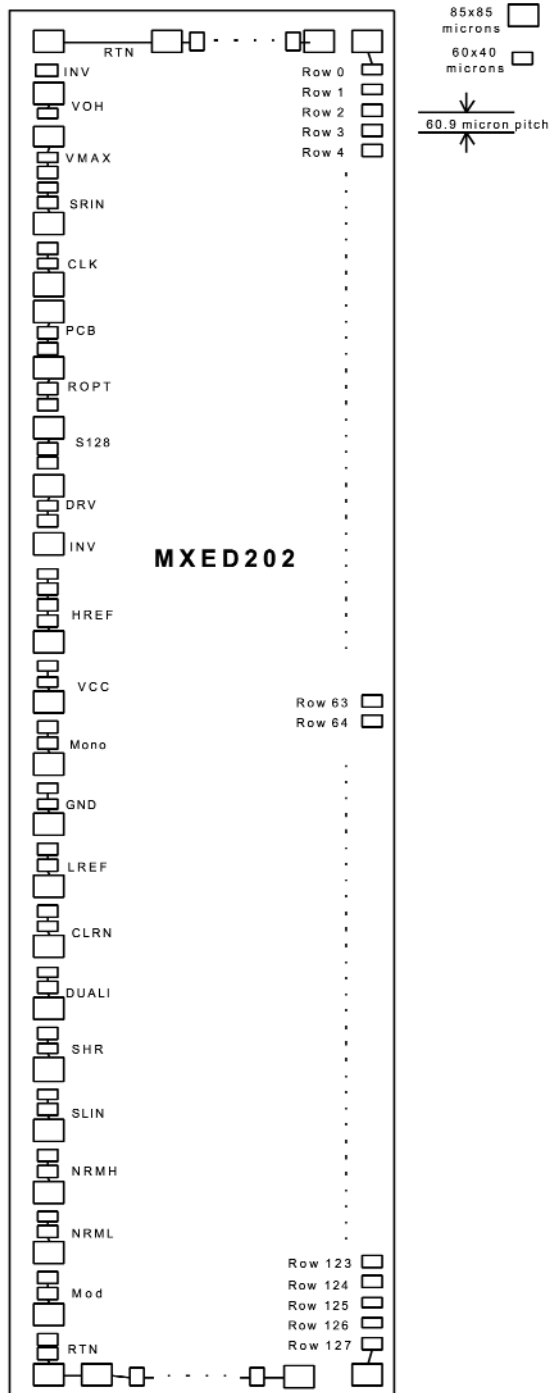
| S128 | DUAL • SHR |     |            |        | Outputs Used                          |
|------|------------|-----|------------|--------|---------------------------------------|
|      | 00         | 01  | 10         | 11     |                                       |
| 0    | 127,123    | 0,4 | 127,123,63 | 0,4,64 | Rows 4-123<br>(Rows 0-3, 124-127 N/C) |
| 1    | 127        | 0   | 127,63     | 0,64   | Rows 0-127                            |

PACKAGE AND PINOUT

This drawing illustrates the pin ordering and relative locations of the bond pads, only. See the MXED202 Semiconductor Die specification<sup>(2)</sup> for exact coordinates.

Top View:

---- Not To Scale ----



**PIN LIST**

| Name                 | I/O/A | Description   |
|----------------------|-------|---|
| RTN                  | I     | <u>ReTUR</u> N for all display current. (Low impedance ground connection, typically)  |
| GND                  | I     | <u>Grou</u> ND, the negative return for all chip current and the digital logic "zero" reference level.  |
| VCC                  | I     | The logic voltage positive supply. MXED202 logic operates between VCC and VSS. Digital inputs should not exceed VCC, VSS  |
| VMAX                 | I     | This <u>V</u> oltage <u>MA</u> Ximum is the highest positive power supply voltage present on the chip, and supplies the display panel precharge current either directly or at derived voltage VOH. Inputs to the chip should not exceed VMAX to avoid forward biasing substrate diodes.   |
| VOH<br>[Page 12]     | I/O/A | Row <u>V</u> oltage <u>O</u> utput <u>H</u> igh supply. This pin is normally connected to an external power supply pin VMAX with bypass capacitor, and to pin DRV. Alternatively, an internal amplifier can generate VOH from an input voltage DRV.   |
| INV<br>[Page 12]     | I     | <u>I</u> N <u>V</u> erting input to Voltage Regulator Op Amp, to which an input Resistor RI and feedback Resistor RF may be connected to develop VOH from VDRV; see DRV pin.  |
| DRV<br>[Page 12]     | I     | When not connected to VOH and VMAX, a <u>D</u> rive <u>R</u> eference <u>V</u> oltage >1V can be connected to the DRV pin. Note: If VDRV <0.3V, all row circuitry is powered down.  |
| SHR                  | I     | Active high static <u>S</u> Hift <u>R</u> ight control input: When SHR=1, the token bit travels from R0 to R127, with SRIN being the token input, SLIN the token output. When SHR=0, the token bit travels from R127 to R0, with SLIN being the token input, SRIN the token output. SHR should always be driven to the desired logic level.         |
| SRIN                 | I/O   | <u>S</u> hift <u>R</u> ight <u>I</u> Nput. This bi-directional pin is the token input when SHR is high, and the token output (for synchronization or cascading) when SHR is low. When configured as an input, this pin should always be driven. Normally low, SRIN should be driven high once per frame to enter the token into the shift register. |
| SLIN                 | I/O   | <u>S</u> hift <u>L</u> eft <u>I</u> Nput. This bi-directional pin is the token input when SHR is low, and the token output (for synchronization or cascading) when SHR is high. When configured as an input, this pin should always be driven. Normally low, SLIN should be driven high once per frame to enter the token into the shift register.  |
| DUAL                 | I     | <u>D</u> UAL tokens are seeded into the first and middle shift register cells from SRIN or SLIN when DUAL is static active high. When low, a single token is active.  |
| CLK                  | I     | The rising edge of the <u>C</u> lock input shifts the token along the internal shift register to activate successive rows. The display Row Scan Rate is the CLK frequency times the number of tokens.   |
| PCB<br>[Pages 9-11]  | I     | If the <u>P</u> re <u>C</u> harge <u>B</u> ar input is low on the rising edge of CLK, all row outputs will be switched to the same voltage (see MONO) to enable display panel precharging until PCB returns high. Holding PCB high disables MXED202 precharge.  |
| MONO<br>[Pages 9-11] | I     | Enables MXED202 row driver precharge of <u>M</u> ONOchromatic displays, if PCB=0. The MONO input has no effect if PCB=1.  |
| MOD<br>[Pages 9-11]  | I     | This input <u>M</u> ODifies precharge timing  |
| S128                 | I     | <u>S</u> elect <u>1</u> 28 row driver output mode when static active high. When low, 120 row driver output mode is selected.  |

## Pin List (Continued)

|                       |       |  |
|-----------------------|-------|--|
| ROPT<br>[Pages 10-11] | I/O/A | Resistor OPTion pin, normally N/C for digitally controlled precharge timing (PCB), or when precharge is disabled. When a resistor R is connected between ROPT and PCB, and a capacitor C is connected between PCB and VSS, the precharge time will be $RC/1.65$ when measured from the rising edge of CLK to the falling edge of ROPT. The timing components should be selected such that $RC/1.65$ not exceed 10% of the row active time. |
| RSTB                  | I     | <u>ReSeT</u> Bar, static, active low reset input, clears all the shift register cells, eliminating token content.  |
| R(n)                  | O     | Row driver outputs. R(0)-R(127) are used in 128 output mode, S128=1. Only R(4)-R(123) should be connected when S128=0.   |
| HREF                  | O     | High voltage <u>REF</u> erence is an internally generated PFET switch drive voltage (approximately five-volts less than VOH), which should be bypassed to VOH with a 2200pF external capacitor.  |
| LREF                  | O     | Low voltage <u>REF</u> erence is an internally generated NFET switch drive voltage (approximately five-volts above GND), which should be bypassed to GND with a 2200pF external capacitor.   |
| NRMH                  | O     | Test Pin, N/C  |
| NRML                  | O     | Test Pin, N/C  |

## ELECTRICAL SPECIFICATION

Note: positive currents flow into the part, negative currents flow out of the part.

## Absolute Maximum Ratings:

| Parameter           | Operating Condition | Min  | Typ | Max  | Units |
|---------------------|---------------------|------|-----|------|-------|
| Ambient temp        | -                   | -65  |     | 155  | °C    |
| Low voltage supply  | -                   | -0.3 |     | 7.0  | V     |
| High voltage supply | -                   | -0.3 |     | 35.0 | V     |

## Operating Conditions:

Unless otherwise stated, all parameters are specified for the following operating conditions.

| Parameter             | Sym  | Operating Condition | Min | Typ | Max | Units |
|-----------------------|------|---------------------|-----|-----|-----|-------|
| Ambient temp          | TA   | -                   | 0   | -   | 70  | °C    |
| Low voltage supply    | VCC  | -                   | 3.0 | -   | 5.5 | V     |
| High voltage supplies | VMAX | -                   | 5.0 | -   | 30  | V     |
| Clock Frequency       | CLK  | -                   | -   | -   | 100 | kHz   |

## Chip Supply Currents - Exclusive of Load

| Parameter                      | Sym   | Operating Condition                                   | Min | Typ | Max | Units   |
|--------------------------------|-------|---|-----|-----|-----|---------|
| Logic Supply, Operating        | IVCC  | $V_{DRV} > 1V, f_{CLK} < 100kHz$<br>$3V < VCC < 5.5V$ | -   | 140 | 210 | $\mu A$ |
| Logic Supply, Powerdown        | IVCC  | $V_{DRV} < 0.3V, 3V < VCC < 5.5V$                     | -   | 15  | 25  | $\mu A$ |
| High Voltage Supply, Operating | IVMAX | $V_{DRV} > 1V, f_{CLK} < 100kHz$<br>$9V < MAX < 30V$  | -   | 445 | 700 | $\mu A$ |
| High Voltage Supply, Powerdown | IVMAX | $V_{DRV} < 0.3V, 9V < MAX < 30V$                      | -   | -   | 20  | $\mu A$ |

## Digital Inputs: SHR, SRIN, SLIN, DUAL, CLK, PCB, MONO, S128, RSTB

| Parameter          | Sym               | Operating Condition  | Min     | Typ | Max | Units   |
|--------------------|-------------------|--|---------|-----|-----|---------|
| Input low voltage  | VIL               | -  | -       | -   | 0.4 | V       |
| Input high voltage | VIH               | -  | VCC-0.4 | -   | -   | V       |
| Input current      | II                | -  | -10     | -   | 10  | $\mu A$ |
| Clock Rise Time    | CLK <sub>RT</sub> | -  | -       | -   | 5   | nS      |
| Clock Fall Time    | CLK <sub>FT</sub> | -  | -       | -   | 5   | nS      |
| Clock Duty Cycle   | CLK <sub>%</sub>  | -  | 20      | -   | 80  | %       |
| Setup Time         | T <sub>Set</sub>  | Time in advance of 10% rising edge of CLK that inputs SHR, SRIN, SLIN, DUAL, PCB, MONO, S128, CLRB must be at valid input logic levels to take effect on next clock cycle. | 50      | -   | -   | nS      |
| Hold Time          | T <sub>Hold</sub> | Time subsequent to 90% rising edge of CLK that inputs SHR, SRIN, SLIN, DUAL, PCB, MONO, S128, CLRB must be valid to take effect on next rising edge of the clock (CLK).    | 50      | -   | -   | nS      |

## Digital Outputs: SRIN, SLIN, ROPT

| Parameter                                       | Sym               | Operating Condition                  | Min     | Typ | Max | Units      |
|---|-------------------|--------------------------------------|---------|-----|-----|------------|
| Output low voltage                              | VOL               | I <sub>out</sub> = 200 $\mu A$       | -       | -   | 0.4 | V          |
| Output high voltage                             | VOH               | I <sub>out</sub> = -200 $\mu A$      | VCC-0.4 | -   | -   | V          |
| Output rise/fall time                           | TRF               | 10 to 90 %, C <sub>load</sub> = 5 pF | -       | -   | 5   | nS         |
| Precharge Timing Resistor connected to pin ROPT | R <sub>ROPT</sub> | Pages 9-11                           | 50      | -   | 200 | k $\Omega$ |

**Analog Inputs: DRV, INV**

| Parameter                         | Sym         | Operating Condition | Min | Typ | Max      | Units      |
|-----------------------------------|-------------|---------------------|-----|-----|----------|------------|
| DRV Pin Input Resistance          | $DRV_{Rin}$ | -                   | 10  | -   | -        | k $\Omega$ |
| DRV Pin Input Capacitance         | $DRV_{Cin}$ | -                   | -   | -   | 10       | pF         |
| Voltage Range of DRV Input        | $V_{DRV}$   | -                   | 1.0 | -   | VMAX-1.5 | V          |
| Feedback Resistor from VOH to INV | $R_F$       | -                   | 10  | -   | 100      | k $\Omega$ |
| Input Resistor from INV to GND    | $R_I$       | -                   | 10  | -   | 100      | k $\Omega$ |
| Gain Ratio                        | $R_F / R_I$ | -                   | 0.1 | -   | 10       | -          |

**Analog Outputs: VOH, HREF, LREF, R(n)**

Bypass capacitors to GND: CVOH=10 $\mu$ F; CHREF, CLREF =2nF

| Parameter                            | Sym         | Operating Condition                                      | Min | Typ | Max | Units     |
|--------------------------------------|-------------|--|-----|-----|-----|-----------|
| Precharge Voltage                    | VOH         | $I_{out_{avg}} = 100 \mu A$ , CLOAD=1000pF               | 5   | -   | 30  | V         |
| Precharge Ripple                     | $VOH_{ac}$  | Voltage Regulator Active,<br>$I_{out_{avg}} = 100 \mu A$ | -   | -   | 100 | mV<br>p-p |
| Row 0-127 Output Pulldown Resistance | $Row_{ON}$  | $V_{ROW} < 5V$<br>(to enable OLED turn-on)               | -   | -   | 20  | $\Omega$  |
| Row 0-127 Output Pullup Resistance   | $Row_{OFF}$ | $V_{ROW} > (VOH-2V)$<br>(to disable OLED turn-on)        | -   | -   | 300 | $\Omega$  |
| Row 0-127 Chip Output Capacitance    | $C_{Row}$   | Per output   | -   | -   | 20  | pF        |



**PRECHARGE:**

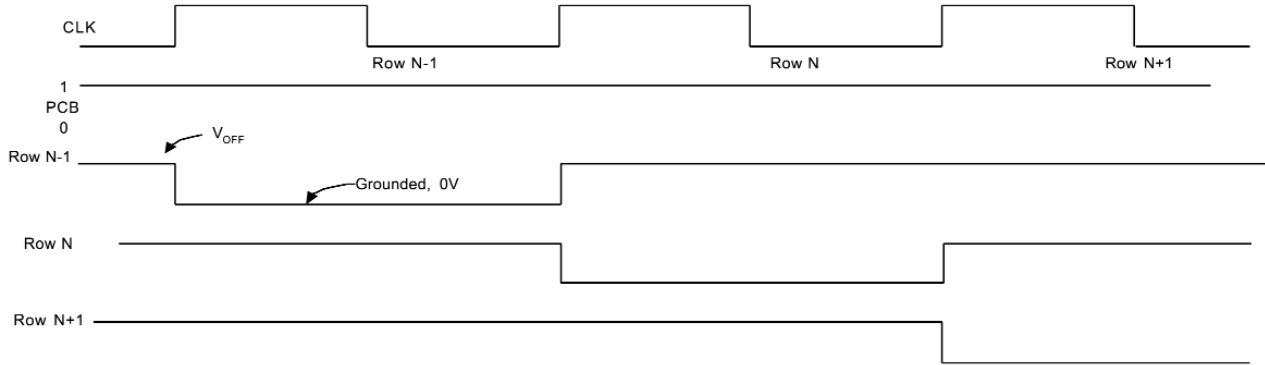
(Organic) Light-Emitting Diodes are current controlled devices, their photonic output (luminance) being proportional to the time-average charge passed through them. To pass charge, the forward voltage must first reach the diode “on” threshold. In passive-matrix panel displays, OLED’s are connected in n-row x m-column matrix fashion. In the row multiplex scheme, where a single row of OLED’s is activated at a time, the parasitic capacitance of the n-1 “off” rows of OLED’s appears connected to the columns - this capacitance must be charged to the “on” threshold before current flows through the selected “on” row diodes. If the column drive current alone were to charge this capacitance, much of the allotted row time would be consumed in just reaching the “on” threshold. Therefore, to improve the efficiency of the display, and to make luminance directly proportional to column current-magnitude and current-duty cycle, the MXED102 and MXED202 Display drivers support optional voltage precharge. In all precharge options, a predetermined voltage is impressed upon the diodes. For instance, the user may configure the precharge voltage to be near the OLED “on threshold,” to bias the diodes to the onset of conduction.

The Timing Diagrams, Pages 10-11, illustrate the Prechage Options:

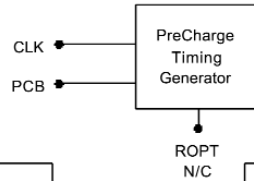
| Condition | Precharge  |
|-----------|--|
| PCB=1     | No Precharge   |
| MONO=1    | A Monochromatic Precharge voltage may be applied via the MXED202 Row Driver, as a function of CLK, PCB, MOD. During the Discharge interval, all Row and Column driver outputs are grounded, discharging all pixels. At the beginning of the Active interval, a selected Precharge Voltage is applied to all but the next active row, and the column drivers source data-driven currents. |
| MONO=0    | Color/Monochrome Precharge by the MXED102 Column Driver, as function of CLK, PCB.  |

**TIMING DIAGRAMS**

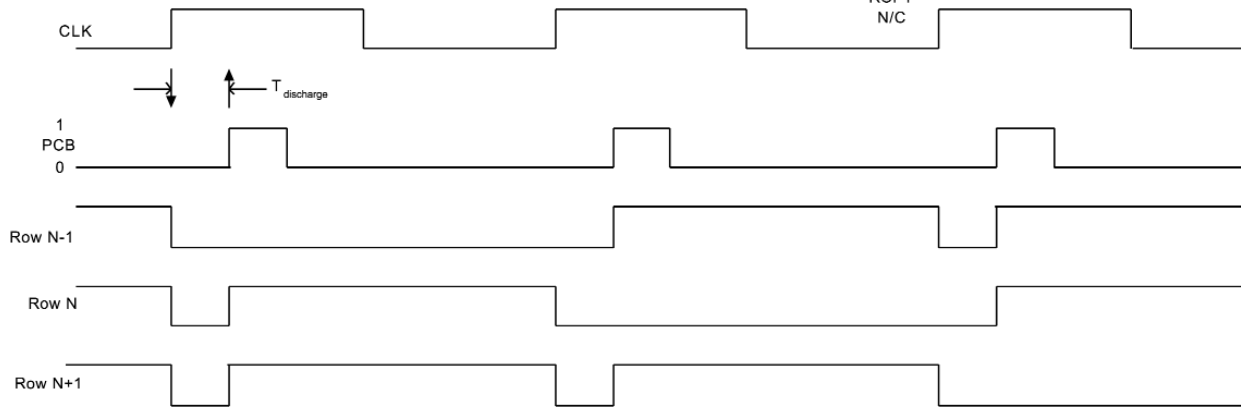
**No Precharge**



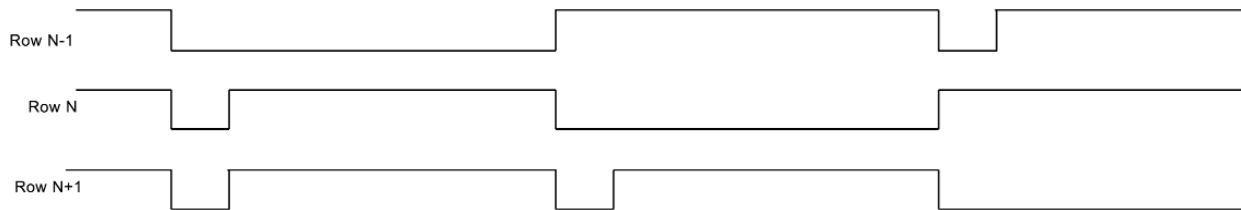
**PCB-Driven Precharge; Discharge Time is from rising edge of CLK to rising edge of PCB**



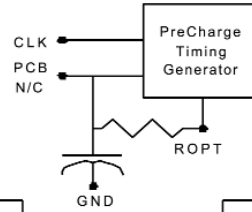
MONO=1, MOD = 0



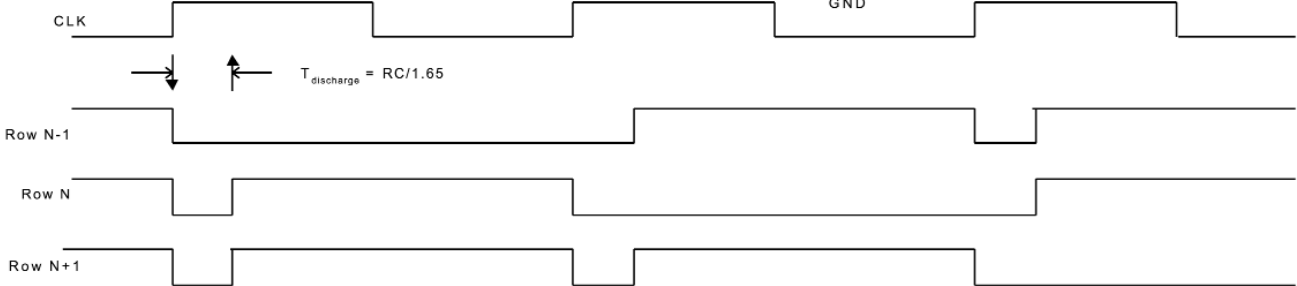
MONO=1, MOD = 1



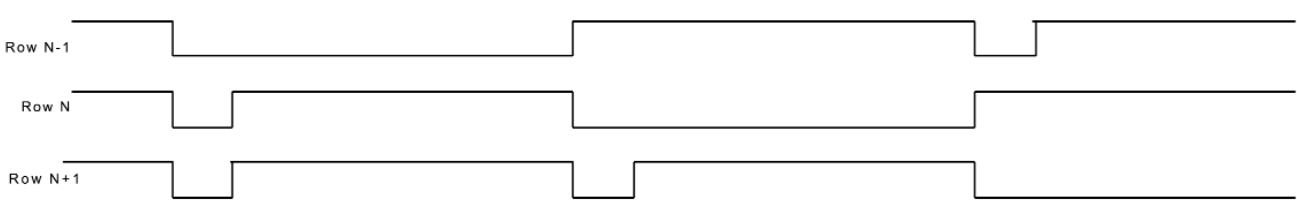
**Monostable-Timed Precharge; Discharge Time is from rising edge of CLK to 0.6 RC time constants**



MONO=1, MOD = 0

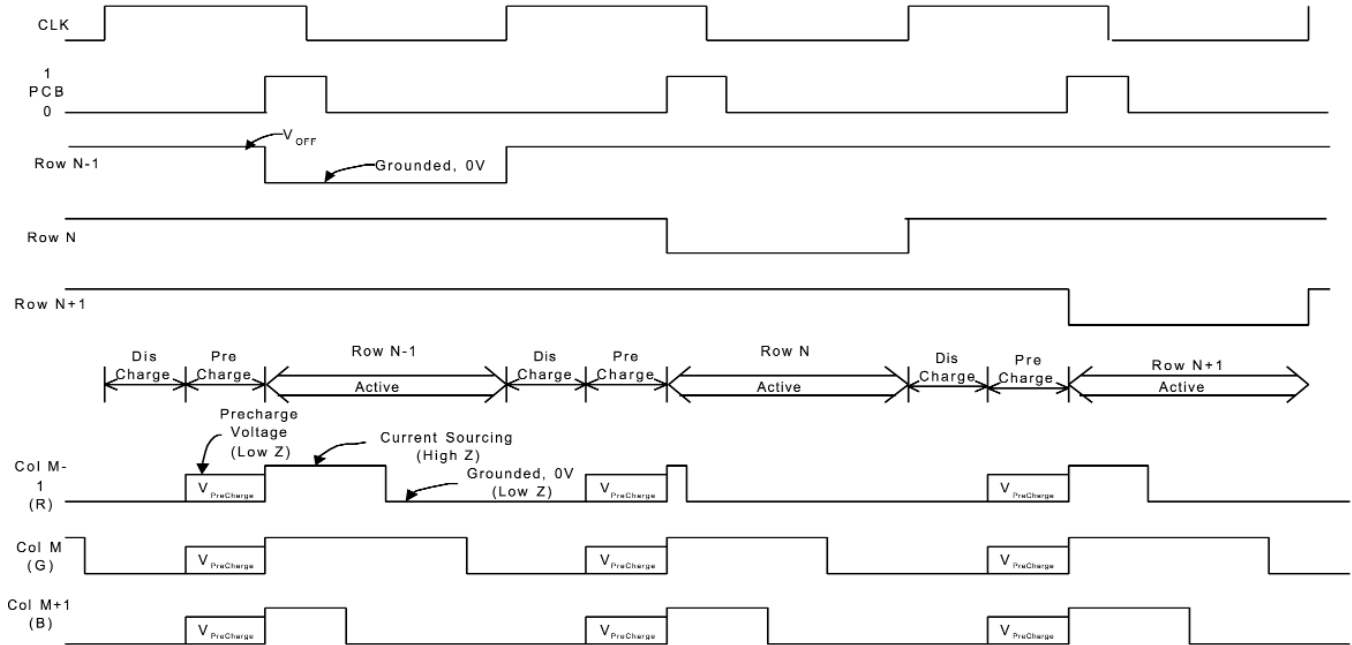


MOD = 1

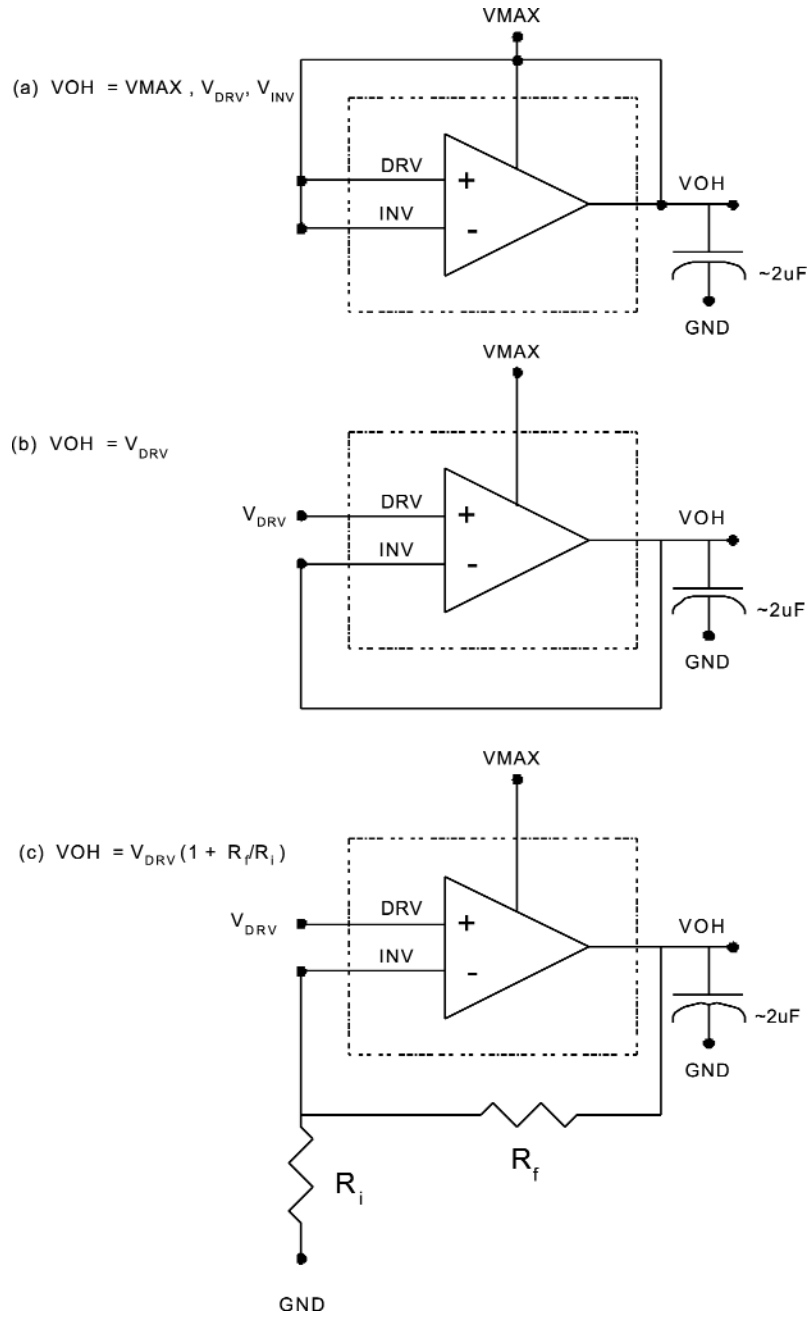


**Optional MXED102 Column Driver Discharge and Precharge**

MONO=0



VOH OPTIONS



**SEMICONDUCTOR DIE DATA SHEET**

The MXED202 is a common cathode (row) driver for Passive Matrix Organic Light Emitting Diode (OLED) and Polymer Light Emitting Diode (PLED, PolyLED, LEP,...etc.) displays, with anodes connected to the columns. This document specifies the physical and mechanical properties of MXED202 semiconductor die, as provided in wafer form.

**DIMENSIONS**

## Die Size

“X Dimensions” Center Scribe to Center Scribe: 8270  $\mu\text{m}$

“Y Dimensions” Scribe to Center Scribe: 2300  $\mu\text{m}$

## Die Thickness

Unthinned (Non Back Lapped Wafer) Thickness: 25 mil

**BONDING PADS**

Locations and Sizes -Driver Outputs

| <b>MXED202 PAD LOCATIONS</b>          |                  |        |      |                  |        |
|---------------------------------------|------------------|--------|------|------------------|--------|
| COORDINATES REFERENCE LOWER LEFT EDGE |                  |        |      |                  |        |
| Name                                  | RECT(60X BY 40Y) |        | Name | RECT(60X BY 40Y) |        |
|                                       | X                | Y      |      | X                | Y      |
| R0                                    | 1,882.7          | 7856.8 | R64  | 1,882.7          | 3959.2 |
| R1                                    | 1,882.7          | 7795.9 | R65  | 1,882.7          | 3898.3 |
| R2                                    | 1,882.7          | 7735.0 | R66  | 1,882.7          | 3837.4 |
| R3                                    | 1,882.7          | 7674.1 | R67  | 1,882.7          | 3776.5 |
| R4                                    | 1,882.7          | 7613.2 | R68  | 1,882.7          | 3715.6 |
| R5                                    | 1,882.7          | 7552.3 | R69  | 1,882.7          | 3654.7 |
| R6                                    | 1,882.7          | 7491.4 | R70  | 1,882.7          | 3593.8 |
| R7                                    | 1,882.7          | 7430.5 | R71  | 1,882.7          | 3532.9 |
| R8                                    | 1,882.7          | 7369.6 | R72  | 1,882.7          | 3472.0 |
| R9                                    | 1,882.7          | 7308.7 | R73  | 1,882.7          | 3411.1 |
| R10                                   | 1,882.7          | 7247.8 | R74  | 1,882.7          | 3350.2 |
| R11                                   | 1,882.7          | 7186.9 | R75  | 1,882.7          | 3289.3 |
| R12                                   | 1,882.7          | 7126.0 | R76  | 1,882.7          | 3228.4 |
| R13                                   | 1,882.7          | 7065.1 | R77  | 1,882.7          | 3167.5 |
| R14                                   | 1,882.7          | 7004.2 | R78  | 1,882.7          | 3106.6 |
| R15                                   | 1,882.7          | 6943.3 | R79  | 1,882.7          | 3045.7 |
| R16                                   | 1,882.7          | 6882.4 | R80  | 1,882.7          | 2984.8 |
| R17                                   | 1,882.7          | 6821.5 | R81  | 1,882.7          | 2923.9 |
| R18                                   | 1,882.7          | 6760.6 | R82  | 1,882.7          | 2863.0 |
| R19                                   | 1,882.7          | 6699.7 | R83  | 1,882.7          | 2802.1 |
| R20                                   | 1,882.7          | 6638.8 | R84  | 1,882.7          | 2741.2 |
| R21                                   | 1,882.7          | 6577.9 | R85  | 1,882.7          | 2680.3 |
| R22                                   | 1,882.7          | 6517.0 | R86  | 1,882.7          | 2619.4 |
| R23                                   | 1,882.7          | 6456.1 | R87  | 1,882.7          | 2558.5 |
| R24                                   | 1,882.7          | 6395.2 | R88  | 1,882.7          | 2497.6 |
| R25                                   | 1,882.7          | 6334.3 | R89  | 1,882.7          | 2436.7 |
| R26                                   | 1,882.7          | 6273.4 | R90  | 1,882.7          | 2375.8 |
| R27                                   | 1,882.7          | 6212.5 | R91  | 1,882.7          | 2314.9 |
| R28                                   | 1,882.7          | 6151.6 | R92  | 1,882.7          | 2254.0 |
| R29                                   | 1,882.7          | 6090.7 | R93  | 1,882.7          | 2193.1 |
| R30                                   | 1,882.7          | 6029.8 | R94  | 1,882.7          | 2132.2 |
| R31                                   | 1,882.7          | 5968.9 | R95  | 1,882.7          | 2071.3 |
| R32                                   | 1,882.7          | 5908.0 | R96  | 1,882.7          | 2010.4 |
| R33                                   | 1,882.7          | 5847.1 | R97  | 1,882.7          | 1949.5 |
| R34                                   | 1,882.7          | 5786.2 | R98  | 1,882.7          | 1888.6 |
| R35                                   | 1,882.7          | 5725.3 | R99  | 1,882.7          | 1827.7 |
| R36                                   | 1,882.7          | 5664.4 | R100 | 1,882.7          | 1766.8 |
| R37                                   | 1,882.7          | 5603.5 | R101 | 1,882.7          | 1705.9 |
| R38                                   | 1,882.7          | 5542.6 | R102 | 1,882.7          | 1645.0 |
| R39                                   | 1,882.7          | 5481.7 | R103 | 1,882.7          | 1584.1 |
| R40                                   | 1,882.7          | 5420.8 | R104 | 1,882.7          | 1523.2 |
| R41                                   | 1,882.7          | 5359.9 | R105 | 1,882.7          | 1462.3 |
| R42                                   | 1,882.7          | 5299.0 | R106 | 1,882.7          | 1401.4 |
| R43                                   | 1,882.7          | 5238.1 | R107 | 1,882.7          | 1340.5 |
| R44                                   | 1,882.7          | 5177.2 | R108 | 1,882.7          | 1279.6 |
| R45                                   | 1,882.7          | 5116.3 | R109 | 1,882.7          | 1218.7 |
| R46                                   | 1,882.7          | 5055.4 | R110 | 1,882.7          | 1157.8 |
| R47                                   | 1,882.7          | 4994.5 | R111 | 1,882.7          | 1096.9 |
| R48                                   | 1,882.7          | 4933.6 | R112 | 1,882.7          | 1036.0 |
| R49                                   | 1,882.7          | 4872.7 | R113 | 1,882.7          | 975.1  |
| R50                                   | 1,882.7          | 4811.8 | R114 | 1,882.7          | 914.2  |
| R51                                   | 1,882.7          | 4750.9 | R115 | 1,882.7          | 853.3  |
| R52                                   | 1,882.7          | 4690.0 | R116 | 1,882.7          | 792.4  |
| R53                                   | 1,882.7          | 4629.1 | R117 | 1,882.7          | 731.5  |
| R54                                   | 1,882.7          | 4568.2 | R118 | 1,882.7          | 670.6  |
| R55                                   | 1,882.7          | 4507.3 | R119 | 1,882.7          | 609.7  |
| R56                                   | 1,882.7          | 4446.4 | R120 | 1,882.7          | 548.8  |
| R57                                   | 1,882.7          | 4385.5 | R121 | 1,882.7          | 487.9  |
| R58                                   | 1,882.7          | 4324.6 | R122 | 1,882.7          | 427.0  |
| R59                                   | 1,882.7          | 4263.7 | R123 | 1,882.7          | 366.1  |
| R60                                   | 1,882.7          | 4202.8 | R124 | 1,882.7          | 305.2  |
| R61                                   | 1,882.7          | 4141.9 | R125 | 1,882.7          | 244.3  |
| R62                                   | 1,882.7          | 4081.0 | R126 | 1,882.7          | 183.4  |
| R63                                   | 1,882.7          | 4020.1 | R127 | 1,882.7          | 122.5  |

The information contained on this page is preliminary. Although the order of the bond pad will remain the same, the XY dimensions in the final document may vary slightly. Please take this possibility into consideration when doing any chip on board layouts.

## Interface Input/Output

| Name | RECT(60X BY 40Y) |        | SQ(85X BY 85Y) |        |
|------|------------------|--------|----------------|--------|
|      | X                | Y      | X              | Y      |
| RTN  | 0                | 110.0  | 0              | 0.0    |
|      | 0                | 170.0  |                |        |
| MOD  | 0                | 391.0  | 0              | 282.9  |
|      | 0                | 451.0  |                |        |
| NRML | 0                | 621.9  | 0              | 513.9  |
|      | 0                | 681.8  |                |        |
| NRMH | 0                | 852.9  | 0              | 744.9  |
|      | 0                | 912.8  |                |        |
| SLIN | 0                | 1135.6 | 0              | 1027.6 |
|      | 0                | 1195.6 |                |        |
| SHR  | 0                | 1417.3 | 0              | 1309.2 |
|      | 0                | 1477.3 |                |        |
| DUAL | 0                | 1699.4 | 0              | 1591.3 |
|      | 0                | 1759.4 |                |        |
| RSTB | 0                | 1981.4 | 0              | 1873.4 |
|      | 0                | 2041.4 |                |        |
| LREF | 0                | 2278.0 | 0              | 2170.0 |
|      | 0                | 2338.0 |                |        |
| GND  | 0                | 2518.0 | 0              | 2410.0 |
|      | 0                | 2578.0 |                |        |
| MONO | 0                | 2800.7 | 0              | 2692.6 |
|      | 0                | 2860.7 |                |        |
| VPLS | 0                | 3031.6 | 0              | 2923.6 |
|      | 0                | 3091.5 |                |        |
| HREF | 0                | 3328.3 | 0              | 3220.2 |
|      | 0                | 3388.3 |                |        |
|      | 0                | 3448.3 |                |        |
|      | 0                | 3508.3 |                |        |
| INV  | NA               | NA     | 0              | 3571.2 |
| DRV  | 0                | 3755.2 | 0              | 3878.1 |
|      | 0                | 3815.2 |                |        |
| S128 | 0                | 4060.7 | 0              | 4183.7 |
|      | 0                | 4120.7 |                |        |
| ROPT | 0                | 4343.4 | 0              | 4466.3 |
|      | 0                | 4403.4 |                |        |
| PCB  | 0                | 4625.7 | 0              | 4748.9 |
|      | 0                | 4685.7 |                |        |
| CLK  | 0                | 5281.1 | 0              | 5173.1 |
|      | 0                | 5341.1 |                |        |
| SRIN | 0                | 5563.0 | 0              | 5455.2 |
|      | 0                | 5623.0 |                |        |
| VMAX | 0                | 6563.2 | 0              | 6685.9 |
|      | 0                | 6623.2 |                |        |
| VOH  | 0                | 7540.6 | 0              | 7605.6 |
| INV  | 0                | 7778.9 | NA             | NA     |
| RTN  |                  |        | 0              | 7928.7 |
|      |                  |        |                |        |
| R0   |                  |        | 1857.7         | 7946.0 |
| R127 |                  |        | 1857.7         | -25.0  |

| RECTANGULAR PAD ORIENTATION |                  |      |                |      |
|-----------------------------|------------------|------|----------------|------|
| Name                        | RECT(40X BY 60Y) |      | SQ(85X BY 85Y) |      |
|                             | X                | Y    | X              | Y    |
| RTN                         |                  |      | 1557.7         | -25  |
| RTN                         | 1497.7           | -25  |                |      |
| RTN                         | 1437.7           | -25  |                |      |
| RTN                         | 1377.7           | -25  |                |      |
| RTN                         | 1317.7           | -25  |                |      |
| RTN                         | 1257.7           | -25  |                |      |
| RTN                         | 1197.7           | -25  |                |      |
| RTN                         | 1137.7           | -25  |                |      |
| RTN                         | 1077.7           | -25  |                |      |
| RTN                         | 1017.7           | -25  |                |      |
| RTN                         | 957.7            | -25  |                |      |
| RTN                         | 897.7            | -25  |                |      |
| RTN                         | 837.7            | -25  |                |      |
| RTN                         | 777.7            | -25  |                |      |
| RTN                         | 717.7            | -25  |                |      |
| RTN                         | 657.7            | -25  |                |      |
| RTN                         | 597.7            | -25  |                |      |
| RTN                         | 537.7            | -25  |                |      |
| RTN                         | 477.7            | -25  |                |      |
| RTN                         | 417.7            | -25  |                |      |
| RTN                         |                  |      | 312.7          | -25  |
| RTN                         |                  |      | 1557.7         | 7946 |
| RTN                         | 1497.7           | 7971 |                |      |
| RTN                         | 1437.7           | 7971 |                |      |
| RTN                         | 1377.7           | 7971 |                |      |
| RTN                         | 1317.7           | 7971 |                |      |
| RTN                         | 1257.7           | 7971 |                |      |
| RTN                         | 1197.7           | 7971 |                |      |
| RTN                         |                  |      | 1092.7         | 7946 |



### CLARE LOCATIONS

Clare Headquarters  
78 Cherry Hill Drive  
Beverly, MA 01915  
Tel: 1-978-524-6700  
Fax: 1-978-524-4900  
Toll Free: 1-800-27-CLARE

Clare Micronix Division  
145 Columbia  
Aliso Viejo, CA 92656-1490  
Tel: 1-949-831-4622  
Fax: 1-949-831-4628

### SALES OFFICES

#### AMERICAS

##### Americas Headquarters

Clare  
78 Cherry Hill Drive  
Beverly, MA 01915  
Tel: 1-978-524-6700  
Fax: 1-978-524-4900  
Toll Free: 1-800-27-CLARE

##### Eastern Region

Clare  
603 Apache Court  
Mahwah, NJ 07430  
Tel: 1-201-236-0101  
Fax: 1-201-236-8685  
Toll Free: 1-800-27-CLARE

##### Central Region

Clare Canada Ltd.  
3425 Harvester Road, Suite 202  
Burlington, Ontario L7N 3N1  
Tel: 1-905-333-9066  
Fax: 1-905-333-1824

##### Western Region

Clare  
1852 West 11th Street, #348  
Tracy, CA 95376  
Tel: 1-209-832-4367  
Fax: 1-209-832-4732  
Toll Free: 1-800-27-CLARE

##### Canada

Clare Canada Ltd.  
3425 Harvester Road, Suite 202  
Burlington, Ontario L7N 3N1  
Tel: 1-905-333-9066  
Fax: 1-905-333-1824

### EUROPE

##### European Headquarters

CP Clare nv  
Bampslaan 17  
B-3500 Hasselt (Belgium)  
Tel: 32-11-300868  
Fax: 32-11-300890

##### France

Clare France Sales  
Lead Rep  
99 route de Versailles  
91160 Champlan  
France  
Tel: 33 1 69 79 93 50  
Fax: 33 1 69 79 93 59

##### Germany

Clare Germany Sales  
ActiveComp Electronic GmbH  
Mitterstrasse 12  
85077 Manching  
Germany  
Tel: 49 8459 3214 10  
Fax: 49 8459 3214 29

##### Italy

C.L.A.R.E.s.a.s.  
Via C. Colombo 10/A  
I-20066 Melzo (Milano)  
Tel: 39-02-95737160  
Fax: 39-02-95738829

##### Sweden

Clare Sales  
Comptronic AB  
Box 167  
S-16329 Spånga  
Tel: 46-862-10370  
Fax: 46-862-10371

##### United Kingdom

Clare UK Sales  
Marco Polo House  
Cook Way  
Bindon Road  
Taunton  
UK-Somerset TA2 6BG  
Tel: 44-1-823 352541  
Fax: 44-1-823 352797

### ASIA PACIFIC

##### Asian Headquarters

Clare  
Room N1016, Chia-Hsin, Bldg II,  
10F, No. 96, Sec. 2  
Chung Shan North Road  
Taipei, Taiwan R.O.C.  
Tel: 886-2-2523-6368  
Fax: 886-2-2523-6369

<http://www.clare.com>

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